

FIG. 1

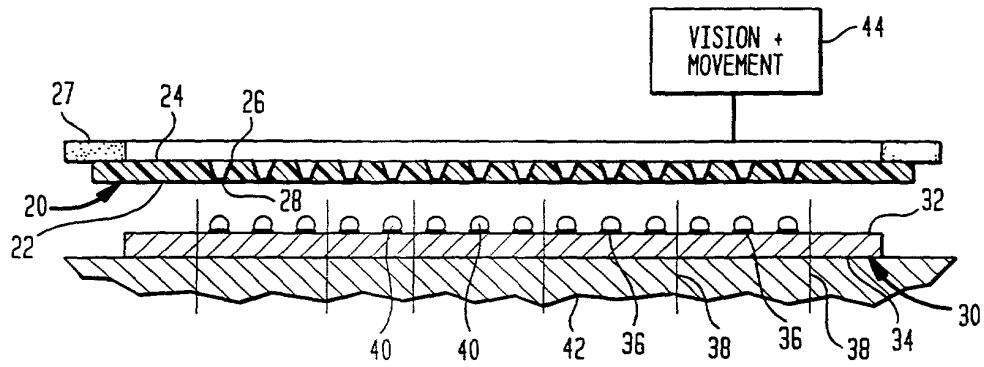


FIG. 2

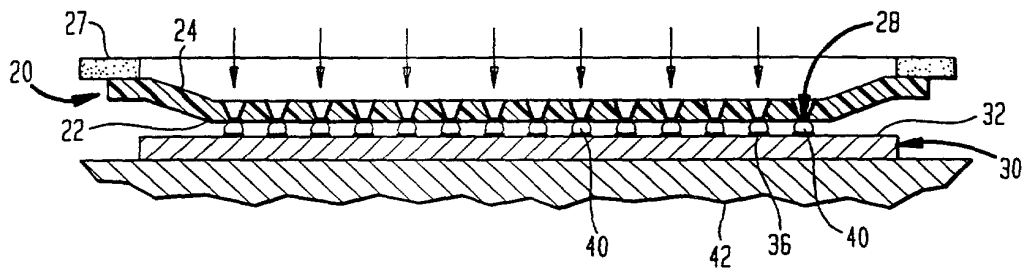


FIG. 3

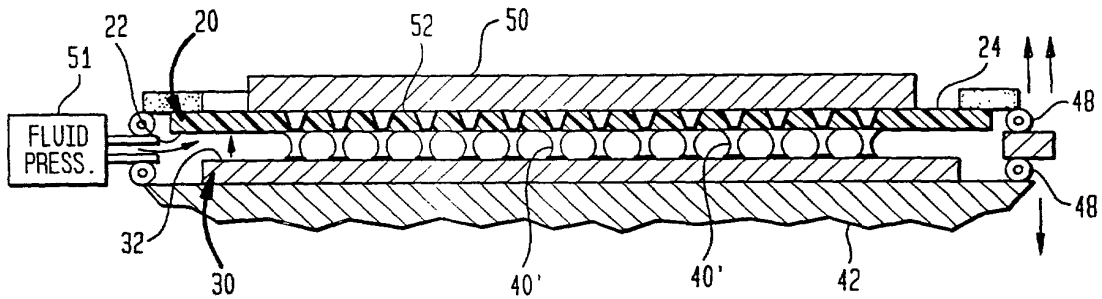


FIG. 4

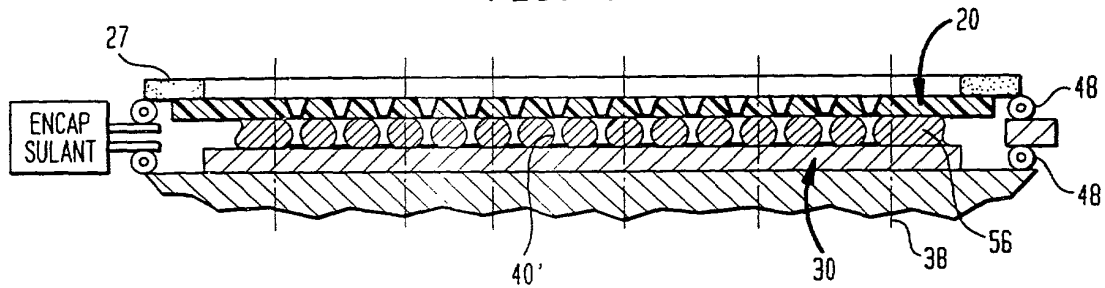
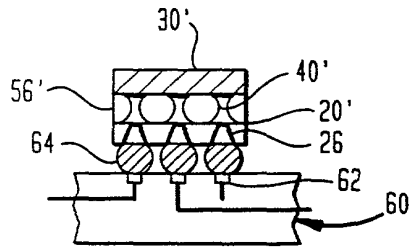


FIG. 6



This diagram shows a second embodiment of the device. It features a substrate 120 with a top layer 127 and a bottom layer 126. A series of vertical structures 128 are formed on the top layer 127. A layer 140 is disposed on the bottom layer 126. A series of vertical structures 136 are formed on the layer 140. A layer 132 is disposed on the bottom layer 126, and a series of vertical structures 130 are formed on the layer 132.

FIG. 15 is a cross-sectional view of a device. It shows a top layer 127, a middle layer 156, and a bottom layer 140'. The bottom layer 140' contains a series of oval-shaped features.

FIG. 10

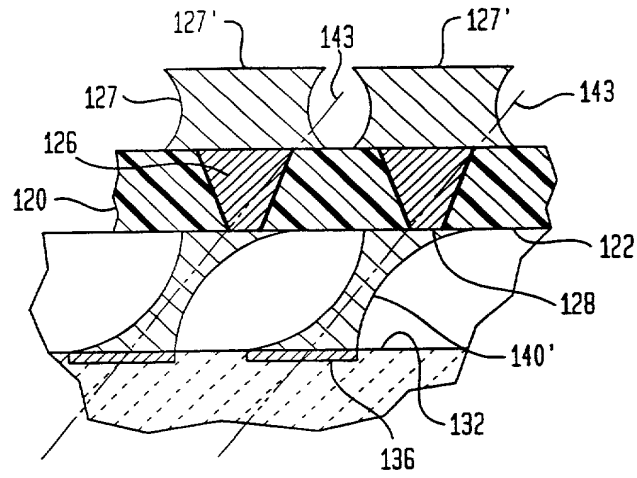


FIG. 11

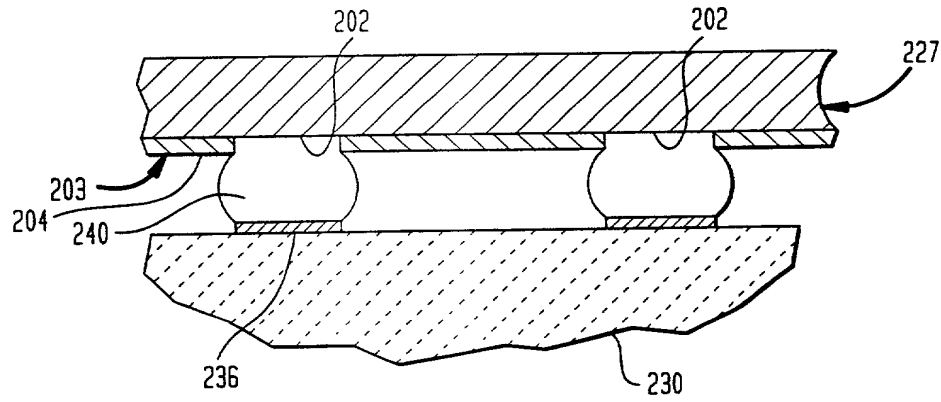


FIG. 12

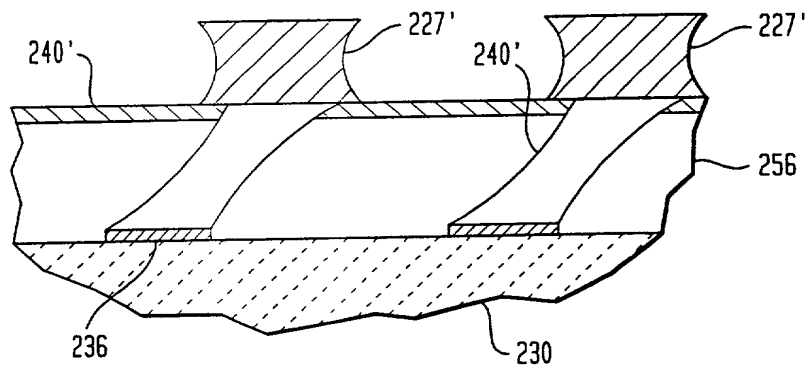


FIG. 13

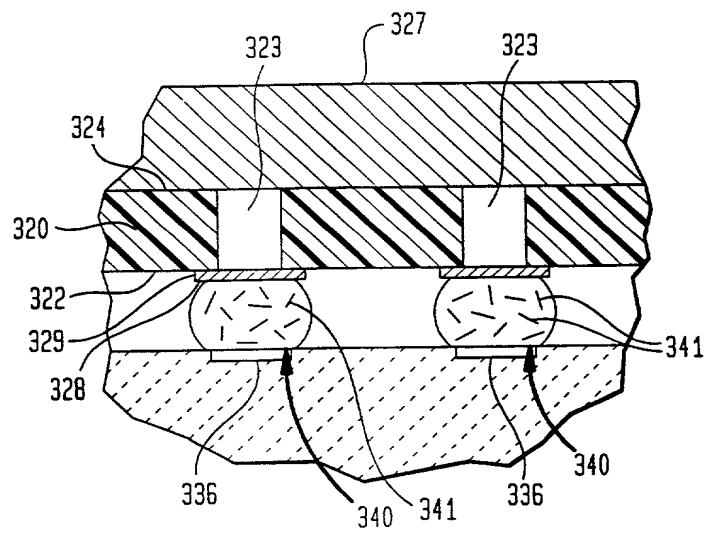


FIG. 14

